

HD74LS78A

Dual J-K Flip-Flops (with Preset, Common Clear, and Common Clock)

REJ03D0419-0300 Rev.3.00 Jul.22.2005

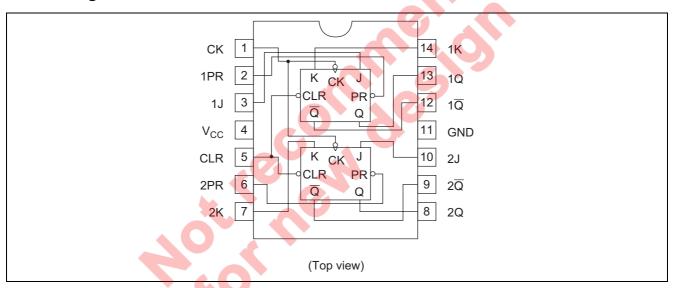
Features

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS78AFPEL	SOP-14 pin (JEITA)	PRSP0014DF-B (FP-14DAV)	FP	EL (2,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

Pin Arrangement



Function Table

		Outputs				
Preset	Clear	Clock	J	K	Q	Q
L	Н	X	Х	Х	Н	L
Н	L	X	Х	Х	L	Н
L	L	X	Х	Х	H*	H*
Н	Н	\downarrow	L	L	Q_0	\overline{Q}_0
Н	Н	\downarrow	Н	L	Н	L
Н	Н	\downarrow	L	Н	L	Н
Н	Н	\downarrow	Н	Н	Toggle	
Н	Н	Н	X	X	Q_0	\overline{Q}_0

Notes: H; high level, L; low level, X; irrelevant, \downarrow ; transition from high to low level,

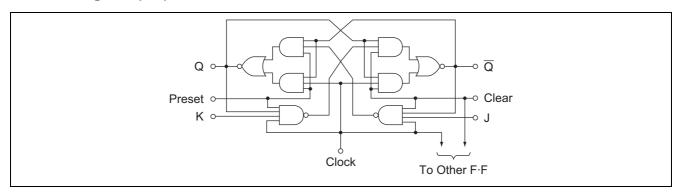
Q₀; level of Q before the indicated steady-state input conditions were established.

 \overline{Q}_0 ; complement of \overline{Q}_0 or level of Q before the indicated steady-state input conditions were established.

Toggle; each output changes to the complement of its previous level on each active transition indicated by \downarrow .

^{*} This configuration is nonstable; that is, it will not persist when preset and clear inputs return to their inactive (high) level.

Block Diagram (1/2)



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit
Supply voltage	Vcc	7	V
Input voltage	V_{IN}	7	V
Power dissipation	P_{T}	400	mW
Storage temperature	Tstg	−65 to +150	°C

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

Recommended Operating Conditions

Item		Symbol	Min	Тур	Max	Unit	
Supply voltage		Vcc	V _{CC} 4.75 5.00		5.25	V	
Output surrent		Іон		-	-400	μΑ	
Output current		l _{OL}	 - 	_	8	mA	
Operating temperature		T _{opr}	-20	25	75	°C	
Clock frequency	Clock frequency		0	_	30	MHz	
Pulse width Clock High		t _w	20	_		nc	
Fuise width	Clear Preset Low	t _w	t _w 25 —		_	ns	
Setup time "H" Data		t _{su}	20↓	_	_	nc	
Setup time "L" Data		t _{su}	20↓	_		ns	
Hold time		t _h	0↓	_		ns	

Electrical Characteristics

 $(Ta = -20 \text{ to } +75 \text{ }^{\circ}\text{C})$

Iter	n	Symbol	min.	typ.*	max.	Unit	Condition		
Input voltag	^	V _{IH}	2.0	_	_	V			
Input voltag	E	V _{IL}	_	_	0.8	V			
Outrot valte ve		V _{OH}	2.7			V	$V_{CC} = 4.75 \; V, \; V_{IH} = 2.7 \; V, \; V_{IL} = 0.8 \; V, \\ I_{OH} = -400 \; \mu A$		
Output volta	ige	W	_	_	0.5	V	$I_{OL} = 8 \text{ mA}$ $V_{CC} = 4.75 \text{ V}, V_{IH} = 2 \text{ V},$		
		V _{OL}	_	_	0.4	v	$I_{OL} = 4 \text{ mA}$ $V_{IL} = 0.8 \text{ V}$		
	J, K		_	_	20				
	Clear		_	_	120		$V_{CC} = 5.25 \text{ V}, V_I = 2.7 \text{ V}$		
	Preset	I _{IH}	_	_	60	μΑ			
	Clock		_	_	160				
	J, K		_	_	-0.4				
Input	Clear	I _{IL} **	_	_	-1.6	mA	$V_{CC} = 5.25 \text{ V}, V_{I} = 0.4 \text{ V}$		
current	Preset		_	1	-0.8	IIIA			
	Clock		_	_	-1.6				
	J, K		_	1	0.1				
	Clear	I _I	_	_	0.6	m Λ	$V_{CC} = 5.25 \text{ V}, V_1 = 7 \text{ V}$		
	Preset		_	1	0.3	mA	VCC = 3.23 V, V = 7 V		
Clock			_	_	0.8				
Short-circuit current	output	Ios	-20	_	-100	mA	Vcc = 5.25 V		
Supply curre	ent***	Icc	_	4	6	mA	V _{CC} = 5.25 V		
Input clamp	voltage	V _{IK}	_		-1.5	V	$V_{CC} = 4.75 \text{ V}, I_{IN} = -18 \text{ mA}$		

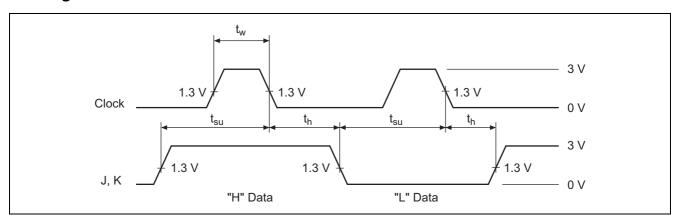
Notes: * $V_{CC} = 5 \text{ V}$, $Ta = 25^{\circ}C$

Switching Characteristics

$$(V_{CC} = 5 \text{ V}, \text{Ta} = 25^{\circ}\text{C})$$

								(cc / /
Item	Symbol	Inputs	Outputs	min.	typ.	max.	Unit	Condition
Maximum clock frequency	f _{max}			30	45		MHz	
Propagation delay time	t _{PLH}	Clear	Q, $\overline{\mathbb{Q}}$	_	15	20	ns	$C_L = 15 \text{ pF}, R_L = 2 \text{ k}\Omega$
Propagation delay time	t _{PHL}	Preset Clock	Q, Q	_	15	20	ns	

Timing Definition



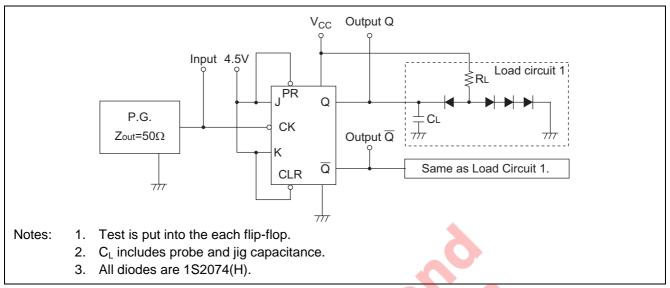
^{**} I_{IL} should not be measured when preset and clear inputs are low at same time.

^{***} With all outputs open, I_{CC} is measured with the Q and \overline{Q} outputs high in turn. At the time of measurement, the clock input is grounded.

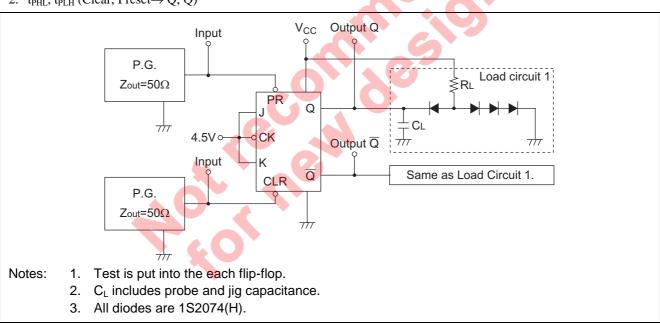
Testing Method

Test Circuit

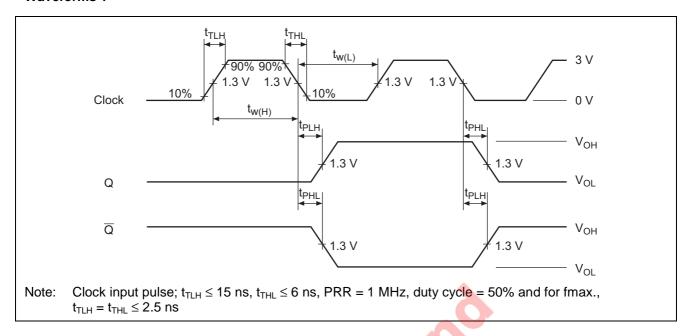
1. f_{max} , t_{PLH} , t_{PHL} , (Clock \rightarrow Q, \overline{Q})



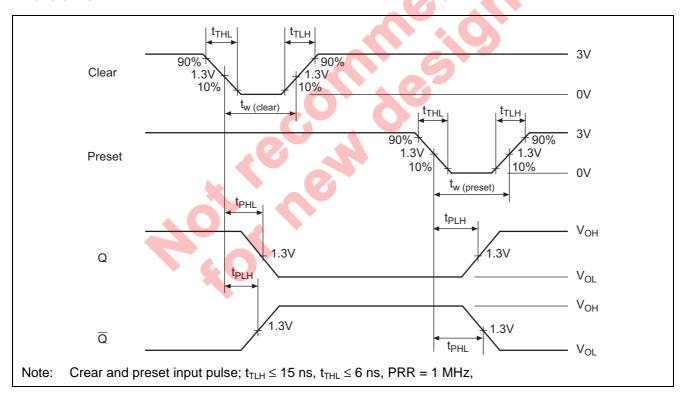
2. t_{PHL} , t_{PLH} (Clear, Preset \rightarrow Q, \overline{Q})



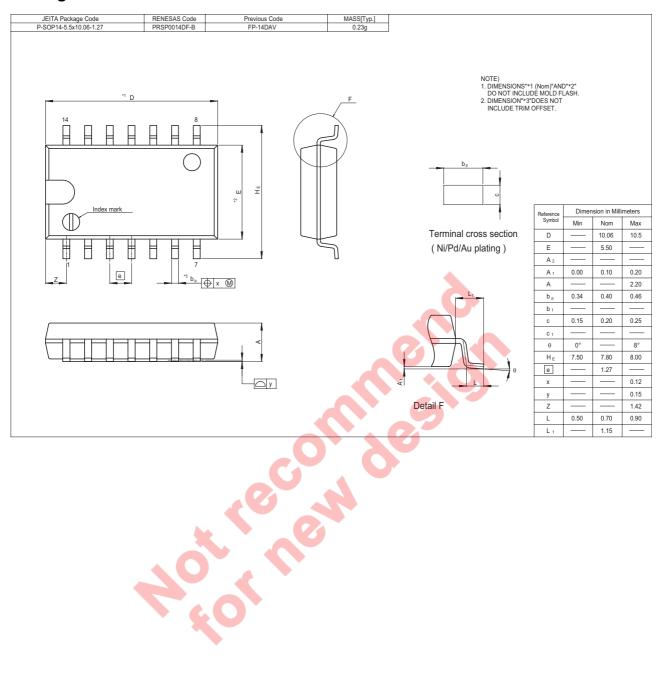
Waveforms 1



Waveforms 2



Package Dimensions



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